

## 74F2244

### Octal Buffer/Line Driver with 25Ω Series Resistors in Outputs

#### General Description

The F2244 is an octal buffer/line driver designed to drive the capacitive inputs of MOS memory drivers, address drivers, clock drivers and bus-oriented transmitters/receivers.

The 25Ω series resistors in the outputs reduce ringing and eliminate the need for external resistors.

#### Features

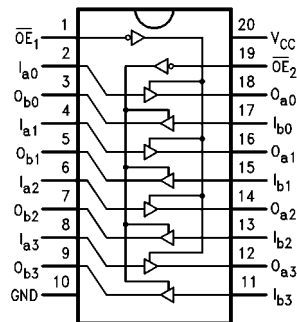
- 3-STATE outputs drive bus lines or buffer memory address registers
- 12 mA source current
- 25Ω series resistors in outputs eliminate the need for external resistors.
- Designed to drive the capacitive inputs of MOS devices
- Guaranteed 4000V minimum ESD protection

#### Ordering Code:

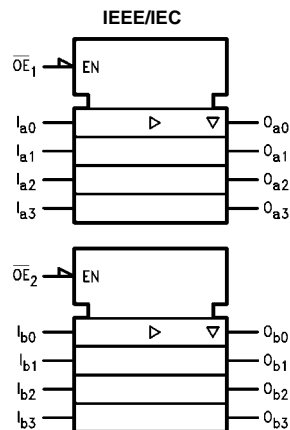
Order Number	Package Number	Package Description
74F2244SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F2244MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74F2244PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### Connection Diagram



#### Logic Symbol



74F2244 Octal Buffer/Line Driver with 25Ω Series Resistors in Outputs

## Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input $I_{IH}/I_{IL}$ Output $I_{OH}/I_{OL}$
$\overline{OE}_1, \overline{OE}_2$	3-STATE Output Enable Input (Active LOW)	1.0/1.667	20 $\mu$ A/-1 mA
$OE_2$	3-STATE Output Enable Input (Active HIGH)	1.0/1.667	20 $\mu$ A/-1 mA
$I_{an}, I_{bn}$	Inputs	1.0/2.667 (Note 1)	20 $\mu$ A/-1.6 mA
$O_{an}, O_{bn}$	Outputs	750/20	-15 mA/12 mA

Note 1: Worst-case F2244 disabled

## Truth Table

$\overline{OE}_1$	$I_{an}$	$O_{an}$	$\overline{OE}_2$	$I_{bn}$	$O_{bn}$
H	X	Z	H	X	Z
L	H	H	L	H	H
L	L	L	L	L	L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

**Absolute Maximum Ratings**(Note 2)

Storage Temperature	–65°C to +150°C
Ambient Temperature under Bias	–55°C to +125°C
Junction Temperature under Bias	–55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	–0.5V to +7.0V
Input Voltage (Note 3)	–0.5V to +7.0V
Input Current (Note 3)	–30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V <sub>CC</sub> = 0V)	
Standard Output	–0.5V to V <sub>CC</sub>
3-STATE Output	–0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)
ESD Last Passing Voltage (Min)	4000V

**Recommended Operating Conditions**

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

**Note 2:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 3:** Either voltage limit or current limit is sufficient to protect inputs.

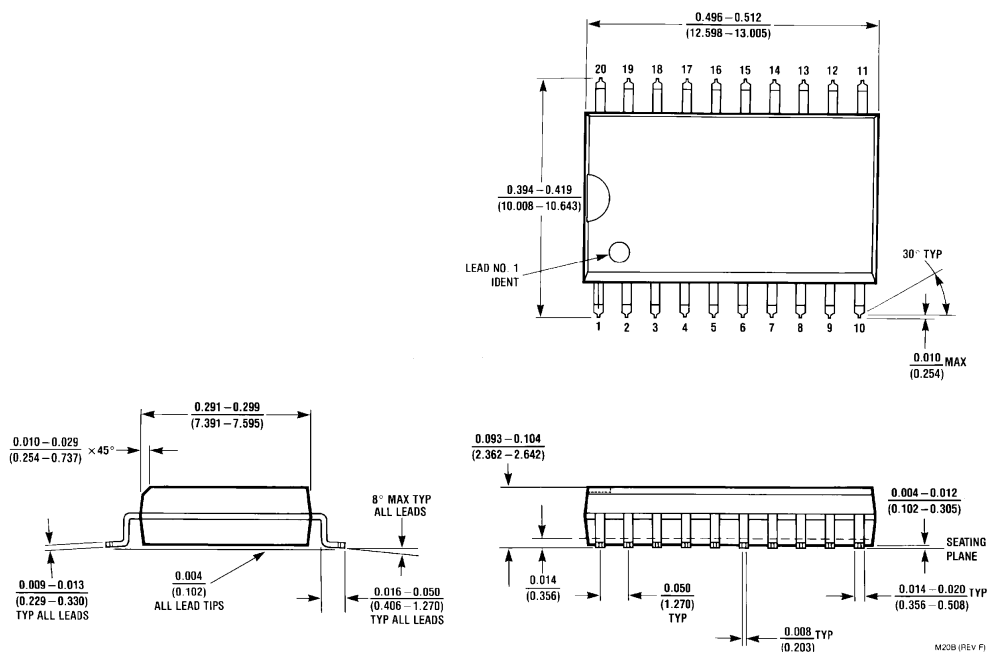
**DC Electrical Characteristics**

Symbol	Parameter	Min	Typ	Max	Units	V <sub>CC</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			–1.2	V	Min	I <sub>IN</sub> = –18 mA
V <sub>OH</sub>	Output HIGH Voltage	10% V <sub>CC</sub> 10% V <sub>CC</sub> 5% V <sub>CC</sub>	2.4 2.0 2.7		V	Min	I <sub>OH</sub> = –3 mA I <sub>OH</sub> = –15 mA I <sub>OH</sub> = –3 mA
V <sub>OL</sub>	Output LOW Voltage		0.50 0.75		V	Min	I <sub>OL</sub> = 1 mA I <sub>OL</sub> = 12 mA
I <sub>IH</sub>	Input HIGH Current		5.0		μA	Max	V <sub>IN</sub> = 2.7V
I <sub>BVI</sub>	Input HIGH Current Breakdown Test		7.0		μA	Max	V <sub>IN</sub> = 7.0V
I <sub>CEX</sub>	Output HIGH Leakage Current		50		μA	Max	V <sub>OUT</sub> = V <sub>CC</sub>
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA All other pins grounded
I <sub>OD</sub>	Output Leakage Circuit Current		3.75		μA	0.0	V <sub>IOD</sub> = 150 mV All other pins grounded
I <sub>IL</sub>	Input LOW Current		–1.0 –1.6		mA	Max	V <sub>IN</sub> = 0.5V (OE <sub>1</sub> , OE <sub>2</sub> , OE <sub>2</sub> ) V <sub>IN</sub> = 0.5V (I <sub>n</sub> )
I <sub>OZH</sub>	Output Leakage Current		50		μA	Max	V <sub>OUT</sub> = 2.7V
I <sub>OZL</sub>	Output Leakage Current		–50		μA	Max	V <sub>OUT</sub> = 0.5V
I <sub>OS</sub>	Output Short-Circuit Current	–100		–225	mA	Max	V <sub>OUT</sub> = 0V
I <sub>CCH</sub>	Power Supply Current		40	60	mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply Current		60	90	mA	Max	V <sub>O</sub> = LOW
I <sub>CCZ</sub>	Power Supply Current		60	90	mA	Max	V <sub>O</sub> = HIGH Z

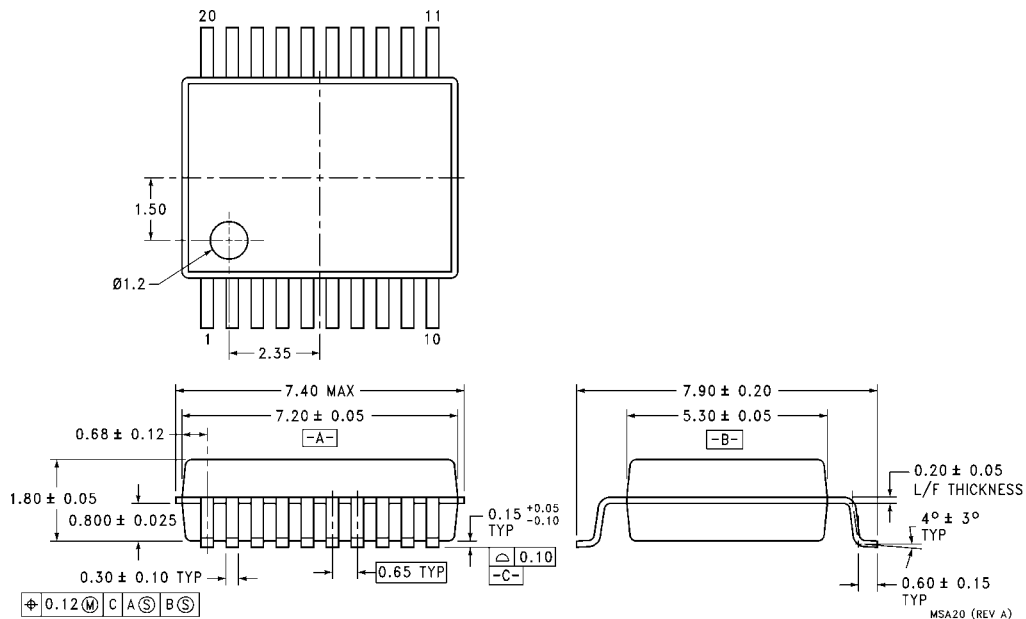
## AC Electrical Characteristics

Symbol	Parameter	T <sub>A</sub> = +25°C V <sub>CC</sub> = +5.0V C <sub>L</sub> = 50 pF			T <sub>A</sub> = -55°C to +125°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = 0°C to +70°C C <sub>L</sub> = 50 pF		Units
		Min	Typ	Max	Min	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.5		7.0	2.0	6.5	1.5	7.0	ns
t <sub>PHL</sub>	Data to Output	2.5		8.0	2.0	7.0	2.0	8.0	
t <sub>PZH</sub>	Output Enable Time	1.5		9.0	2.0	7.0	1.0	9.5	ns
t <sub>PZL</sub>		2.5		11.5	2.0	8.5	2.5	12.0	
t <sub>PHZ</sub>	Output Disable Time	1.5		9.0	2.0	7.0	1.0	9.5	
t <sub>PLZ</sub>		1.5		8.5	2.0	7.5	1.5	9.5	

**Physical Dimensions** inches (millimeters) unless otherwise noted

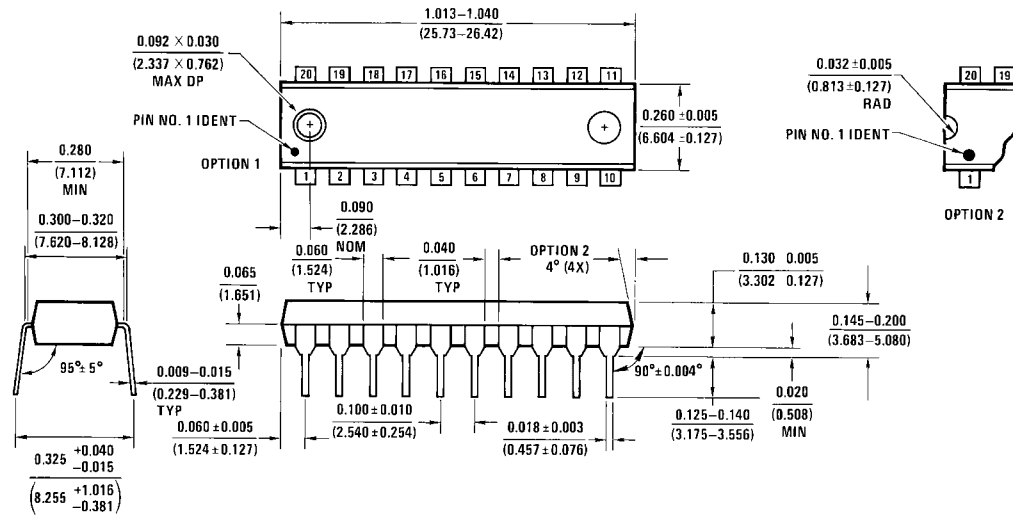


**20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide  
Package Number M20B**



**20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide  
Package Number MSA20**

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide  
Package Number N20A

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